

PMEG3015EH; PMEG3015EJ

30 V, 1.5 A ultra low V_F MEGA Schottky barrier rectifiers

Rev. 03 — 13 January 2010

Product data sheet

1. Product profile

1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifiers with an integrated guard ring for stress protection, encapsulated in small and flat lead SMD plastic packages.

Table 1. Product overview

Type number	Package		Configuration
	Nexperia	JEITA	
PMEG3015EH	SOD123F	-	single diode
PMEG3015EJ	SOD323F	SC-90	single diode

1.2 Features

- Forward current: ≤ 1.5 A
- Reverse voltage: ≤ 30 V
- Ultra low forward voltage
- Small and flat lead SMD plastic packages

1.3 Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Inverse polarity protection
- Low power consumption applications

1.4 Quick reference data



Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_F	forward current	$T_{sp} \leq 55$ °C	-	-	1.5	A
V_R	reverse voltage		-	-	30	V
V_F	forward voltage	$I_F = 1.5$ A	[1] -	440	550	mV

[1] Pulse test: $t_p \leq 300$ μ s; $\delta \leq 0.02$.

2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	 sym001
2	anode	 001aab540	

[1] The marking bar indicates the cathode.

3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
PMEG3015EH	-	plastic surface mounted package; 2 leads	SOD123F
PMEG3015EJ	SC-90	plastic surface mounted package; 2 leads	SOD323F

4. Marking

Table 5. Marking codes

Type number	Marking code
PMEG3015EH	AE
PMEG3015EJ	EK

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit	
V_R	reverse voltage		-	30	V	
I_F	forward current	$T_{sp} \leq 55\text{ °C}$	-	1.5	A	
I_{FRM}	repetitive peak forward current	$t_p \leq 1\text{ ms}$; $\delta \leq 0.25$	-	4.5	A	
I_{FSM}	non-repetitive peak forward current	square wave; $t_p = 8\text{ ms}$	-	9	A	
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	375	mW
			[2]	-	830	mW
			[1]	-	360	mW
			[2]	-	830	mW
T_j	junction temperature		-	150	°C	

Table 6. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
T_{amb}	ambient temperature		-65	+150	°C
T_{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit		
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air						
			PMEG3015EH	[1][2]	-	-	330	K/W
				[2][3]	-	-	150	K/W
			PMEG3015EJ	[1][2]	-	-	350	K/W
			[2][3]	-	-	150	K/W	
$R_{th(j-sp)}$	thermal resistance from junction to solder point							
		PMEG3015EH		-	-	60	K/W	
		PMEG3015EJ		-	-	55	K/W	

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses. Nomograms for determining the reverse power losses P_R and $I_{F(AV)}$ rating are available on request.

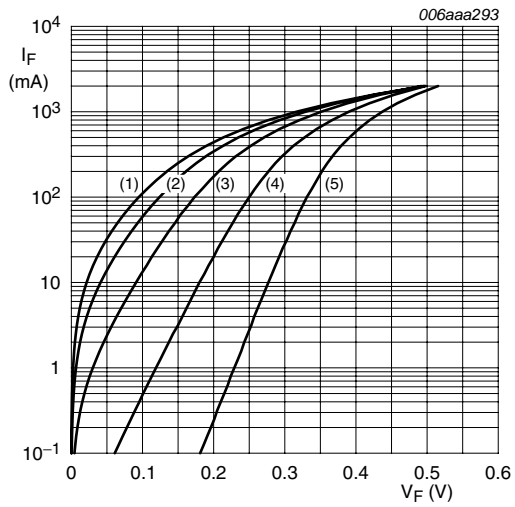
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

7. Characteristics

Table 8. Characteristics $T_{amb} = 25$ °C unless otherwise specified.

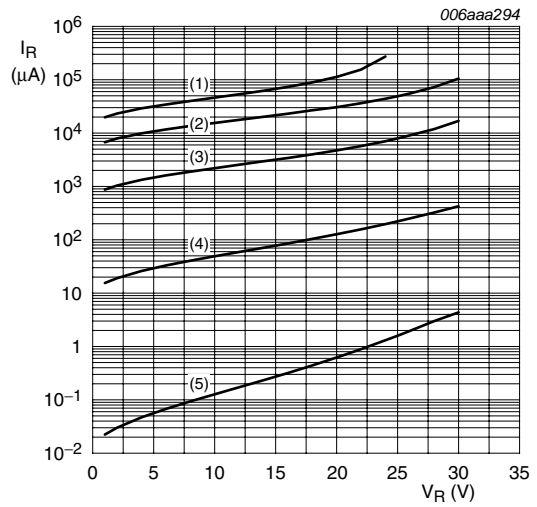
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
V_F	forward voltage	$I_F = 1$ mA	[1]	-	125	160	mV
		$I_F = 10$ mA	[1]	-	185	220	mV
		$I_F = 100$ mA	[1]	-	255	290	mV
		$I_F = 500$ mA	[1]	-	330	380	mV
		$I_F = 1$ A	[1]	-	400	480	mV
		$I_F = 1.5$ A	[1]	-	440	550	mV
I_R	reverse current	$V_R = 10$ V		-	60	150	μA
		$V_R = 30$ V		-	400	1000	μA
C_d	diode capacitance	$V_R = 1$ V; $f = 1$ MHz		-	60	72	pF

[1] Pulse test: $t_p \leq 300$ μs; $\delta \leq 0.02$.



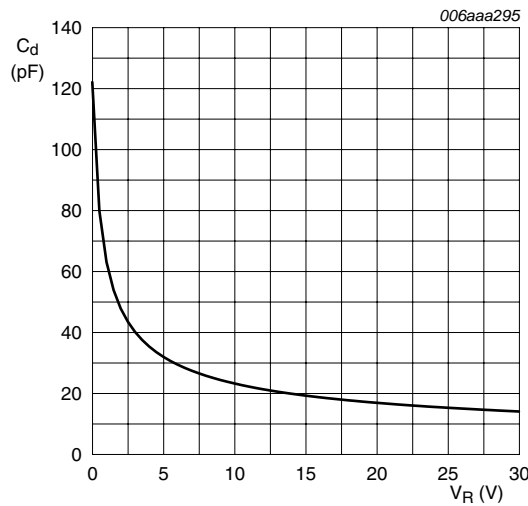
- (1) $T_{amb} = 150\text{ °C}$
- (2) $T_{amb} = 125\text{ °C}$
- (3) $T_{amb} = 85\text{ °C}$
- (4) $T_{amb} = 25\text{ °C}$
- (5) $T_{amb} = -40\text{ °C}$

Fig 1. Forward current as a function of forward voltage; typical values



- (1) $T_{amb} = 150\text{ °C}$
- (2) $T_{amb} = 125\text{ °C}$
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- (4) $T_{amb} = 25\text{ °C}$
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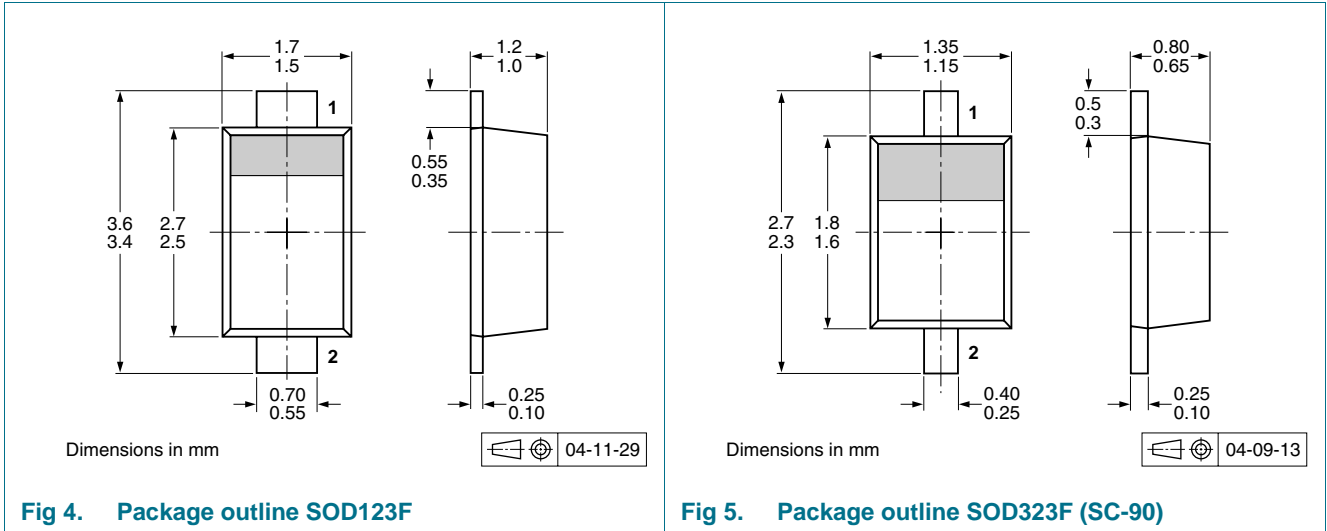
Fig 2. Reverse current as a function of reverse voltage; typical values



$T_{amb} = 25\text{ °C}; f = 1\text{ MHz}$

Fig 3. Diode capacitance as a function of reverse voltage; typical values

8. Package outline



9. Packing information

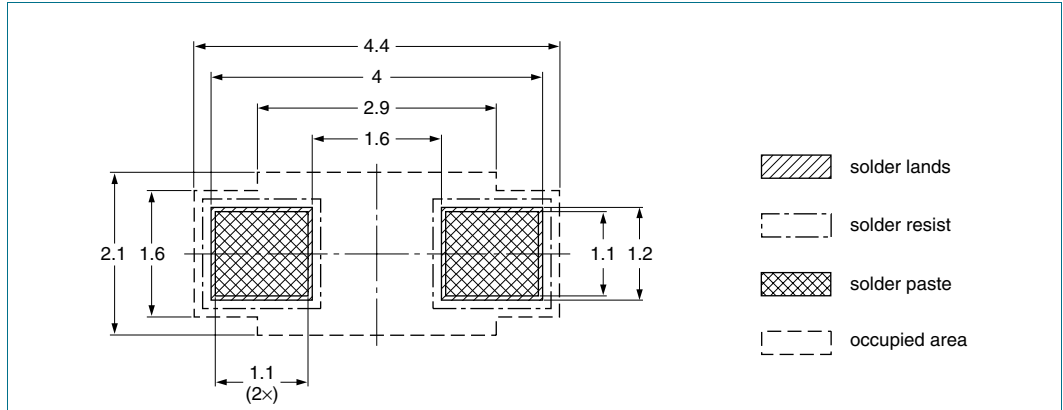
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.^[1]

Type number	Package	Description	Packing quantity	
			3000	10000
PMEG3015EH	SOD123F	4 mm pitch, 8 mm tape and reel	-115	-135
PMEG3015EJ	SOD323F			

[1] For further information and the availability of packing methods, see [Section 13](#).

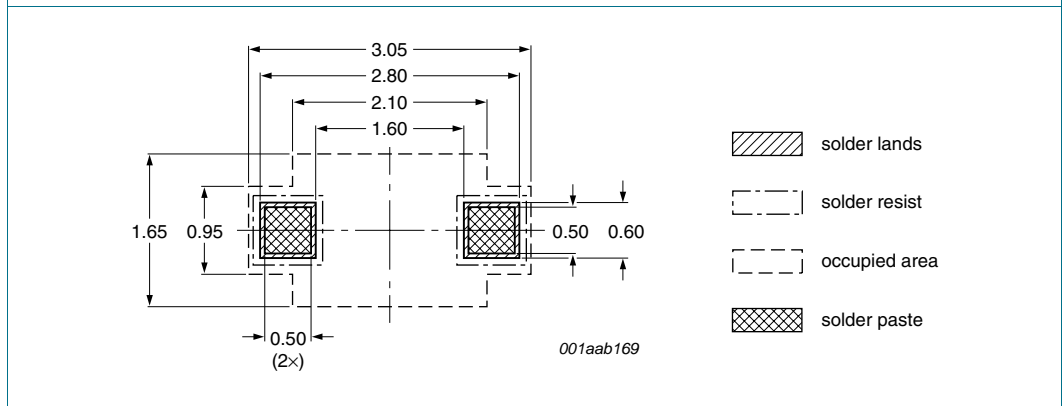
10. Soldering



Reflow soldering is the only recommended soldering method.

Dimensions in mm

Fig 6. Reflow soldering footprint SOD123F



Reflow soldering is the only recommended soldering method.

Dimensions in mm

Fig 7. Reflow soldering footprint SOD323F (SC-90)

11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMEG3015EH_EJ_3	20100113	Product data sheet	-	PMEG3015EH_EJ_2
Modifications:	<ul style="list-style-type: none">This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content.			
PMEG3015EH_EJ_2	20050408	Product data sheet	-	PMEG3015EJ_1
PMEG3015EJ_1	20050303	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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